TOSHIBA Photocoupler GaAs Ired & Photo-Transistor

TLP371, TLP372

Programmable Controllers Telecommunication Solid State Relay

The TOSHIBA TLP371 and TLP372 consists of a gallium arsenide infrared emitting diode optically coupled to a Darlington connected photo-transistor which has an integrated base-emitter resistor to optimize switching speed and elevated temperature characteristics in a six lead plastic DIP package. TLP372 has no-base internal connection for high-EMI environments.

• Current transfer ratio: 1000% (min)

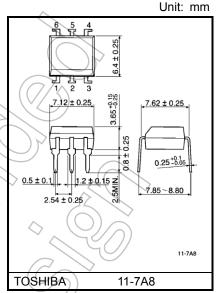
Isolation voltage : 5000 Vrms (min)

• UL recognized : UL1577, file no. E67349

cUL approved(TLP371): CSA Component Acceptance Service No. 5A

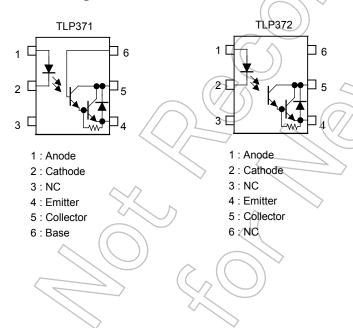
File No.E67349

CQC approved(TLP371): GB4943.1,GB8898 Japan Factory



Weight: 0.4 g (typ.)

Pin Configurations (top view)



Start of commercial production 1986-03



Absolute Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit
Forward current		lF	60	mA
	Forward current derating (Ta ≥ 39°C)	ΔIF/°C	-0.7	mA/°C
	Peak forward current (100 µs pulse, 100 pps)	IFP	1	Α
LED	Reverse voltage	V _R	5	V
	Diode power dissipation	PD	70	mW
	Diode power dissipation derating (Ta ≥39 °C)	ΔP _D /°C	-0.81	mW/°C
	Junction temperature	Tj	125	°C
	Collector-emitter voltage	VCEO	300	V
	Collector-base voltage (TLP371)	V _{CBO}	300	V
	Emitter-collector voltage	VECO	0.3	V
ctor	Emitter-base voltage (TLP371)	VEBO	7	C(v)
Detector	Collector current	lc (7)	150	mA
	Power dissipation	PC	300	mW)
	Power dissipation derating (Ta ≥ 25°C)	ΔPc/°C	-3.0	mW/°C
	Junction temperature	Tj	125	°C
Storage temperature range		T _{stg}	-55 to 125	°C
Оре	erating temperature range	Topr	-55 to 100	°C
Lea	d soldering temperature (10 s)	T _{sol}	260	°C
Total package power dissipation		PT (350	mW
Total package power dissipation derating (Ta ≥ 25°C)		ΔP _T /°C	-3.5	mW/°C
Isola	ation voltage (AC, 60 s, R.H. ≤ 60%) (Note 1)	BVS	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1: Device considered a two terminal device: Pins 1, 2 and 3 shorted together and pins 4,5 and 6 shorted together.

Recommended Operating Conditions

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply-voltage	Vcc	_	_	200	V
Forward current	lF	I	16	25	mA
Collector current	Ic	-	_	120	mA
Operating temperature	Topr	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.



Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	IF = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	IR	V _R = 5 V	_	_	10	μA
	Capacitance	СТ	V = 0 V, f = 1 MHz		30	-	pF
	Collector-emitter breakdown voltage	V(BR)CEO	IC = 0.1 mA	300	_	-	V
	Emitter-collector breakdown voltage	V(BR)ECO	IE = 0.1 mA	0.3	_	-	V
	Collector-base breakdown voltage (TLP371)	V(BR)CBO	Ic = 0.1 mA	300	-	-	V
	Emitter-base breakdown voltage (TLP371)	V _{(BR)EBO}	I _E = 0.1 mA)) 7	_		V
ţo	Oallantan dada assassat	la-a	V _{CE} = 200 V	1	10	200	nA
Detector	Collector dark current	ICEO	V _{CE} = 200 V, Ta = 85 °C	-	1	20	μΑ
	Collector dark current (TLP371)	ICER	V _{CE} = 200 V, Ta = 85 °C R _{BE} = 10 MΩ	-4	0.5	> 10	μΑ
	Collector dark current (TLP371)	ICBO	V _{CB} = 200 V	4	0.1	1	nA
	DC forward current gain (TLP371)	hFE	V _{CE} = 5 V, I _C = 10 mA		7000	_	
	Capacitance (collector to emitter)	CCE	V = 0 V, f = 1 MHz		10	_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	MIn	Тур.	Max	Unit
Current transfer ratio	Ic/IF	IF = 1 mA, V _{CE} = 1 V	1000	4000	_	%
Saturated CTR	I _C /I _{F(sat)}	IF = 10 mA, V _{CE} = 1 V	500	_	_	%
Base photo-current (TLP371)	IPB.	I _F = 1 mA, V _{CB} = 1 V	_	6	_	μA
Collector-emitter saturation voltage	CV-S	I _C = 10 mA, I _F = 1 mA	_	_	1.0	V
	VCE (sat)	IC = 100 mA, IF = 10 mA	0.3	_	1.2	V





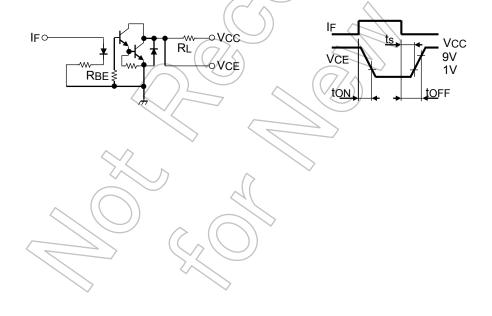
Isolation Characteristics (Ta = 25°C)

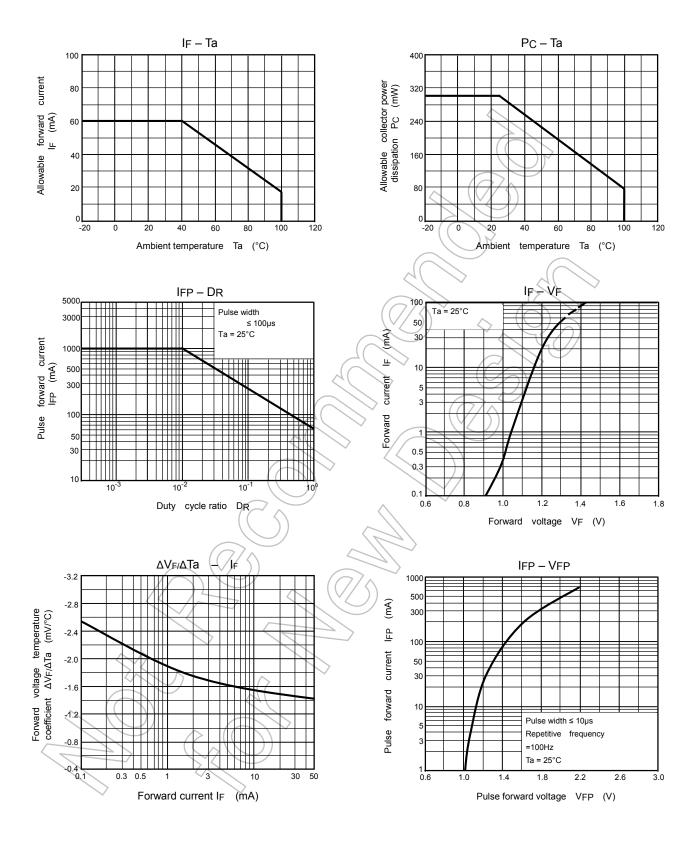
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance (input to output)	Cs	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	Rs	V _S = 500 V, R.H. ≤ 60%	5×10 ¹⁰	10 ¹⁴	_	Ω
		AC, 60 s	5000	_	_	Vrms
Isolation voltage	BVs	AC, 1 s, in oil		10000	_	VIIIIS
		DC, 60 s, in oil		10000	_	Vdc

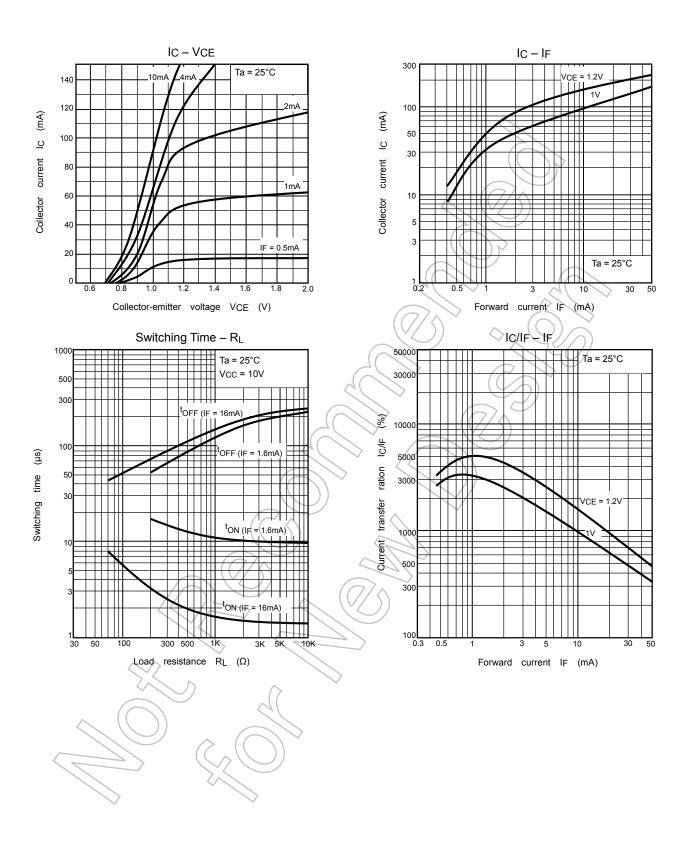
Switching Characteristics (Ta = 25°C)

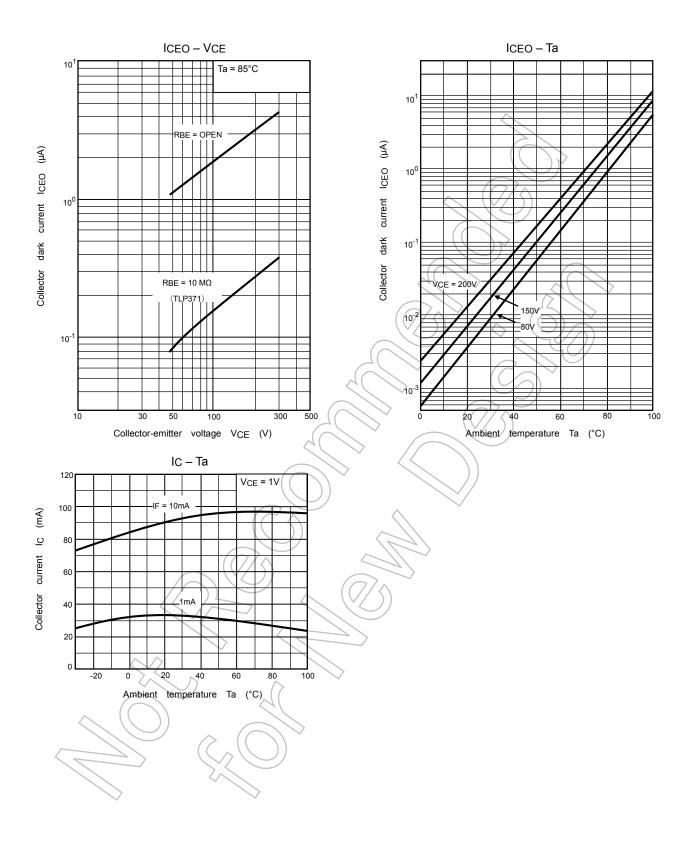
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Rise time	tr		_	40	//	
Fall time	t _f	V _{CC} = 10 V	- (15	<	
Turn-on time	t _{on}	I _C = 10 mA R _L = 100 Ω	-((50	< -	μs
Turn-off time	t _{off}		X	(15)) —	
Turn-on time	ton	$R_L = 180 \Omega$ (Fig.1)	□	3	_	
Storage time	ts	RBE OPEN		45	_	μs
Turn-off time	toff	V _C C = 10 V, I _F = 16 mA		90	_	
Turn-on time	ton	$R_L = 180 \Omega$ (Fig.1)) —	5	-	
Storage time	t _s	$R_{BE} = 10 M\Omega(TLP371)$	_	40	_	μs
Turn-off time	toff	V _{CC} = 10 V, I _F = 16 mA	_	80	_	

Fig.1: Switching time test circuit









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